

# 2SC536M/KM

Rev.F Apr.-2017

## 描述 / Descriptions

SOT-23 塑封封装 NPN 半导体三极管。Silicon NPN transistor in a SOT-23 Plastic Package.

## 特征 / Features

大电流容量，宽阔的安全工作区。

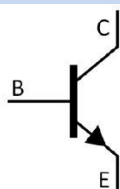
Large current capacity and wide ASO.

## 用途 / Applications

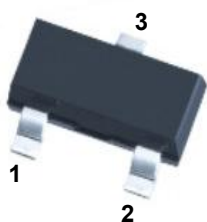
用于小信号一般放大电路。

Small signal general purpose amplifier applications.

## 内部等效电路 / Equivalent Circuit



## 引脚排列 / Pinning



PIN1 : Base      PIN 2 : Emitter      PIN 3 : Collector

## 放大及印章代码 / $h_{FE}$ Classifications & Marking

$h_{FE}$ Classifications Symbol	D	E	F	G	H
$h_{FE}$ Range	60~120	100~200	160~320	280~560	480~960
Marking	H53D	H53E	H53F	H53G	H53H

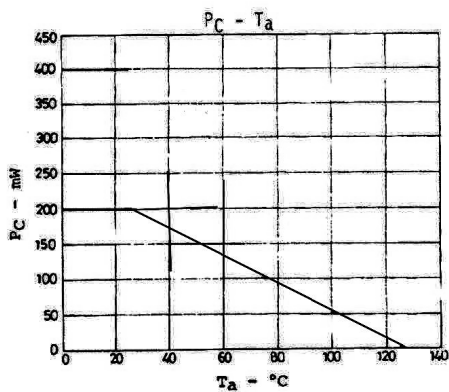
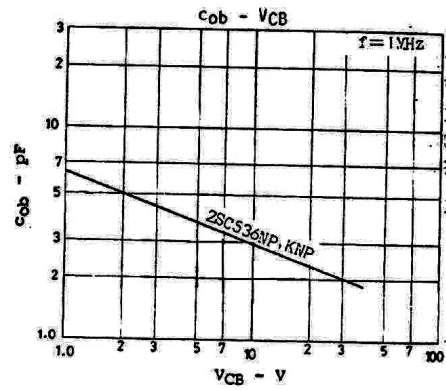
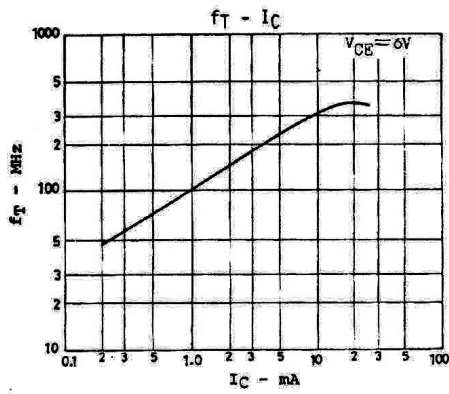
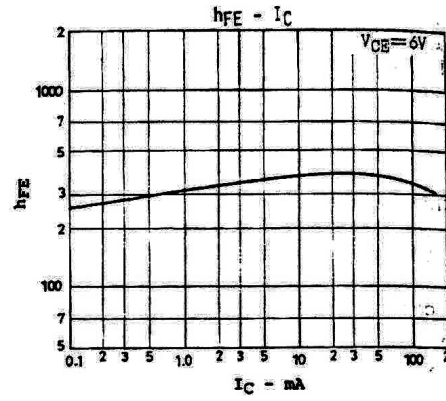
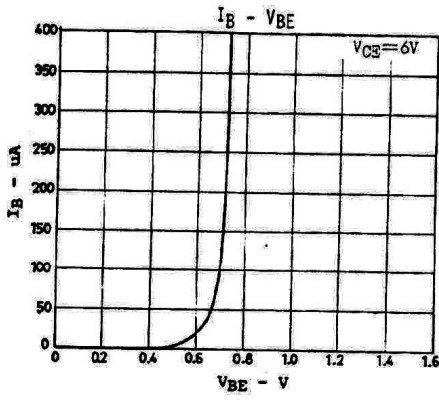
**极限参数 / Absolute Maximum Ratings(Ta=25°C)**

参数 Parameter		符号 Symbol	数值 Rating	单位 Unit
Collector to Base Voltage	2SC536M 2SC536KM	$V_{CBO}$	40 55	V
Collector to Emitter Voltage	2SC536M 2SC536KM	$V_{CEO}$	30 50	V
Emitter to Base Voltage		$V_{EBO}$	5.0	V
Collector Current		$I_C$	100	mA
Collector Current(pulse)		$I_{CP}$	300	mA
Collector Power Dissipation		$P_C$	250	mW
Junction Temperature		$T_j$	150	°C
Storage Temperature Range		$T_{stg}$	-55~150	°C

**电性能参数 / Electrical Characteristics(Ta=25°C)**

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Collector Cut-Off Current	$I_{CBO}$	$V_{CB}=35V$ $I_E=0$			1.0	$\mu A$
Emitter Base Cut-Off Current	$I_{EBO}$	$V_{EB}=4.0V$ $I_C=0$			1.0	$\mu A$
DC Current Gain	$h_{FE}$	$V_{CE}=6.0V$ $I_C=1.0mA$	60		960	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=50mA$ $I_B=5.0mA$			0.5	V
Transition Frequency	$f_T$	$V_{CE}=6.0V$ $I_C=1.0mA$		100		MHz
Collector Output Capacitance	$C_{ob}$	$V_{CB}=6.0V$ $I_E=0$ $f=1.0MHz$		3.5		pF
Collector- Base Time Constant	$C_{C-rbb'}$	$V_{CB}=6.0V$ $I_C=1.0mA$ $f=31.9MHz$		250		pS

电参数曲线图 / Electrical Characteristic Curve



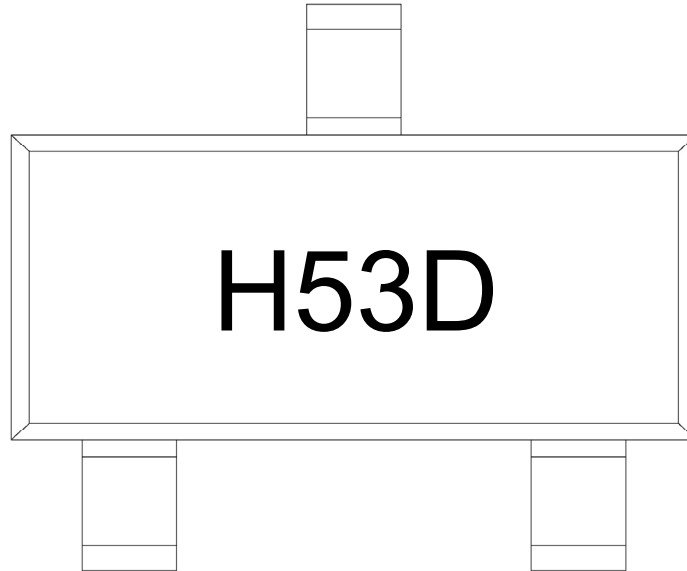
外形尺寸图 / Package Dimensions

SOT-23

单位: mm



印章说明 / Marking Instructions



说明：

H： 为公司代码  
53： 为型号代码  
D： 为  $h_{FE}$  档次代码

Note:

H： Company Code  
53： Product Type Code  
D：  $h_{FE}$  Classifications Symbol Code

**回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)**



说明：

- 1、预热温度 25~150°C，时间 60~90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2~10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

**耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions**

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

**包装规格 / Packaging SPEC.**

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm <sup>3</sup> )		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7" x8	180×120×180	390×385×205

**使用说明 / Notices**